| POL | 9 - 14 V | 0.7 - 2.0 V | 40 A Commont | Positive |
|-----------------|----------|-------------|--------------|----------|
| DC-DC Converter | Input | Output | 40 A Current | Logic |

Description

The NAD12S40-A is a non-isolated DC-DC converter with an input voltage range of 9 V to 14 V and the maximum output current of 40 A. Its output voltage can be adjusted within a range of 0.7 V to 2.0 V.

Operational Features

Input voltage: 9 - 14 VOutput current: 0 - 40 A

Output voltage: 0.7 - 2.0 V
Efficiency: 91.5 % (2.0 V, 40 A)



NAD12S40-A

Mechanical Features

- SMT
- Dimensions: 33.02 mm x 13.46 mm (1.300 in. x 0.530 in.)
- Height: ≤11.00 mm (0.433 in.)
- Weight: about 11.8 g

Control Features

- Remote on/off
- Remote sense
- Output voltage trim

Protection Features

- Input undervoltage protection
- Output overcurrent protection (Hiccup mode)
- Output short circuit protection (Hiccup mode)
- Output overvoltage protection (Self-recovery)
- Overtemperature protection (Self-recovery)

Safety Features

- UL60950-1 and CSA C22.2 No. 60950-1-07
- RoHS6 compliant

Designation Explanation

NAD 12 S 40 -A

1 — Non-isolated, analog, package type

2 — Input voltage: 12 V

3 — Single output

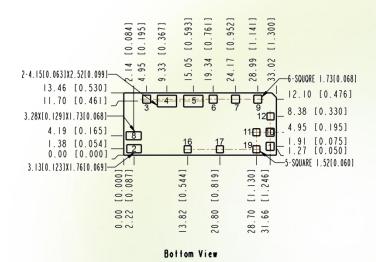
4 — Output current: 40 A

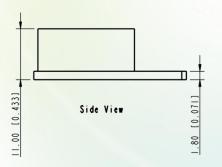
5 — Extension code



EN42PCGJ on the label of the module is the internal model used by the manufacturer.

Mechanical Diagram





Pin Description

| Pin No. | Function | Pin No. | Function |
|---------|------------------|---------|----------|
| 1 | On/Off | 9 | NC |
| 2 | V _{in} | 10 | GND |
| 3 | NC | 11 | SIG_GND |
| 4 | GND | 12 | VS- |
| 5 | V _{out} | 16 | PG |
| 6 | Trim | 17 | NC |
| 7 | VS+ | 19 | NC |
| 8 | GND | | |

M NOTE

- All dimensions in mm [in.]
 Tolerances: x.x ± 0.5 mm [x.xx± 0.02 in.]
 x.xx ± 0.25 mm [x.xxx ± 0.010 in.]
- 2. Tolerances for the lengths and widths of all pads are x.xx ± 0.10 mm [x.xxx ± 0.004 in.].

Electrical Specifications

Conditions: $T_A = -40$ °C to +85°C, $V_{in} = 9$ - 14 V DC, $V_{out} = 0.7$ - 2.0 V DC, unless otherwise notes.

| Parameter | Output | Min. | Тур. | Max. | Units | Notes & Conditions |
|------------------------------------|--------|---------|----------|-------|--------------------|--|
| Absolute maximum ratings | | | | | | |
| Input voltage(Continuous) | - | - | - | 16 | V | - |
| Operating ambient temperature | - | -40 | - | 85 | °C | See the thermal derating curve |
| Storage temperature | - | -55 | - | 125 | °C | - |
| Operating humidity | | 10 | - | 95 | % RH | Non-condensing |
| External voltage applied to On/Off | 1 | 1 | - | 5 | V | |
| Input characteristics | | | | | | |
| Operating input voltage | - | 9 | 12 | 14 | V | - |
| Maximum input current | - | | - | 15 | Α | $V_{in} = 0 - 14 \text{ V}; I_{out} = 40 \text{ A}$ |
| Input capacitance | 1 | 220+60 | 220+60 | - | μF | 220 μF: polymer aluminum capacitor 60 μF: ceramic capacitor |
| No-load loss | 1.2 V | 1 | 1.0 | - | W | $V_{in} = 12 \text{ V}; I_{out} = 0 \text{ A}$ |
| Inrush transient | - | - '- | - | 1 | A²s | |
| Output characteristics | | | | | | |
| Output voltage set point | All | 1 | - | ±1.0 | %V _{oset} | V_{in} = 12 V; I_{out} = 20 A; 0.1% tolerance resistor used to set output voltage |
| Output voltage | All | 0.7 | | 2.0 | V | V _{in} = 9 - 14 V; I _{out} = 0 - 40 A |
| Output line regulation | All | | - | ±0.5 | % | V _{in} = 9 -14 V; I _{out} = 40 A |
| Output load regulation | All | | - | ±0.5 | % | V _{in} = 12 V; I _{out} = 0 - 40 A |
| Regulated voltage precision | All | - | <u> </u> | ±2.0 | % | V _{in} = 9 - 14 V; I _{out} = 0 - 40 A |
| Temperature coefficient | All | - | | ±0.02 | %/°C | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C } (-40^{\circ}\text{F to} +185^{\circ}\text{F})$ |
| External capacitance | All | 470 x 2 | - | 5000 | μF | 470 μF: polymer tantalum capacitor 5000 μF: aluminum capacitor |
| Output current | All | 0 | | 40 | Α | - |
| Output ripple and noise | ≤1.2 V | - | 15 | 30 | mV | Oscillagaana handwidth, 20 MHz |
| (peak to peak) | >1.2 V | - | 30 | 60 | mV | Oscilloscope bandwidth: 20 MHz |
| Output voltage overshoot | All | - | - | 5 | % | The whole range of V_{in} , I_{out} and T_A |
| Output voltage delay time | All | | 3 | 10 | ms | From V _{in} connection to10% V _{out} |
| Output voltage rise time | All | - | 2 | 10 | ms | From 10% V _{out} to 90% V _{out} |
| Switching frequency | All | - | 450 | | kHz | - |

Electrical Specifications

Conditions: $T_A = -40^{\circ}$ C to +85°C, $V_{in} = 9 - 14$ V DC, $V_{out} = 0.7 - 2.0$ V DC, unless otherwise notes.

| Parameter | Output | Min. | Тур. | Max. | Units | Notes & Conditions | | |
|---|----------------|-------------|--------------|-------------|-------------|---|--|--|
| Protection characteristics | | | | | | | | |
| Input undervoltage protection Startup threshold Shutdown threshold Hysteresis | All | 7 5 1 | 8 6 2 | 9 7 3 | V V V | - | | |
| Output overcurrent protection | All | 44 | - | 70 | Α | Hiccup mode | | |
| Output short circuit protection | All | - | - | - | - | Hiccup mode | | |
| Output overvoltage protection | All | 110 | _ | 140 | % | Self-recovery | | |
| Overtemperature protection Threshold Hysteresis | All | 115 5 | 125 - | 135 - | °C °C | Self-recovery The values are obtained by measuring the temperature of MOSFET. | | |
| Dynamic characteristics | | | | | | | | |
| Overshoot amplitude Recovery time | ≤1.2 V | | - | 60 200 | mV µs | Current change rate: 1 A/µs Load: 25% - 50% - 25%; 50% - 75% - 50% | | |
| Overshoot amplitude Recovery time | >1.2 V | - | - | 5 200 | % µs | Current change rate: 1 A/µs Load: 25% - 50% - 25%; 50% - 75% - 50% | | |
| Efficiency | | | | | | | | |
| | 0.7 V | 82.0 | 83.5 | | | | | |
| | 0.8 V | 83.0 | 84.5 | - | | | | |
| | 0.9 V | 83.5 | 85.0 | - - | | | | |
| 100% load | 1.0 V | 85.5 | 87.0 | - | | | | |
| | 1.2 V | 87.0 | 88.5 | - | | | | |
| | 1.5 V | 88.0 | 89.5 | | | | | |
| | 1.8 V | 89.0 | 90.5 | - | | | | |
| | 2.0 V 0.7 V | 90.0 | 91.5 | - | % | V _{in} = 12 V; T _A = 25°C (77°F) | | |
| | 0.7 V | 85.0 | 86.0 86.5 | | | | | |
| | 0.9 V | 85.5 | 87.0 | - | | | | |
| | 1.0 V | 87.5 | 89.0 | | | | | |
| 50% load | 1.0 V | 89.0 | 90.5 | | | | | |
| | 1.5 V | 89.5 | 91.0 | | | | | |
| | 1.8 V | 91.0 | 92.5 | - | | | | |
| | 2.0 V | 91.5 | 93.0 | - | | | | |

Electrical Specifications

Conditions: $T_A = -40$ °C to +85°C, $V_{in} = 9$ - 14 V DC, $V_{out} = 0.7$ - 2.0 V DC, unless otherwise notes.

| Parameter | Output | Min. | Тур. | Max. | Units | Notes & Conditions | | | |
|--|--------|---------------|------|--------------|------------------|--|--|--|--|
| Efficiency | | | | | | | | | |
| | 0.7 V | 82.5 | 84.0 | ı | | | | | |
| | 0.8 V | 83.0 | 84.5 | ı | | | | | |
| | 0.9 V | 83.5 | 85.0 | ı | | | | | |
| 25% load | 1.0 V | 84.0 | 85.5 | 1 | % | \/ _ 12 \/· T _ 25°C (77°E) | | | |
| 25% loau | 1.2 V | 85.0 | 86.5 | - | 70 | $V_{in} = 12 \text{ V}; T_A = 25^{\circ}\text{C } (77^{\circ}\text{F})$ | | | |
| | 1.5 V | 86.5 | 88.0 | | | | | | |
| | 1.8 V | 88.0 | 89.5 | - | | | | | |
| | 2.0 V | 89.0 | 90.5 | 1 | | | | | |
| Other characteristics | | | | | | | | | |
| Remote on/off voltage Low level High level | | -0.20 0.86 | - | 0.50 5.00 | V | Positive logic Connecting to an external voltage is not allowed. | | | |
| Reliability characteristics | | | | | | | | | |
| Mean time between failures (MTBF) | - | - | 2.5 | | Million hours | Telcordia, SR332 Method 1 Case3; $V_n = 12$ V; 80% load; Airflow = 1.5 m/s (300 LFM); $T_A = 40^{\circ}\text{C} (104^{\circ}\text{F})$ | | | |

Characteristic Curves

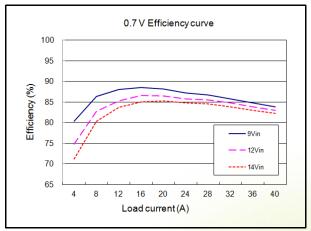


Figure 1: 0.7 V Efficiency

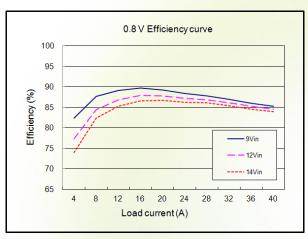


Figure 3: 0.8 V Efficiency

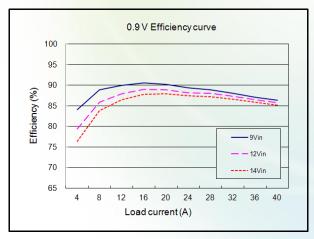


Figure 5: 0.9 V Efficiency

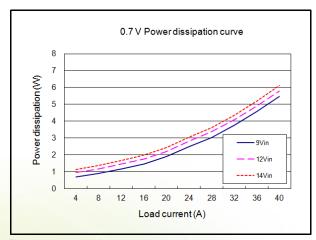


Figure 2: 0.7 V Power dissipation

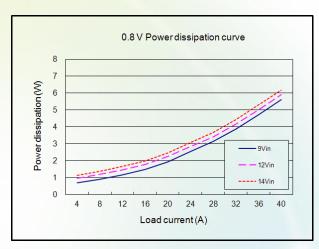


Figure 4:0.8 V Power dissipation

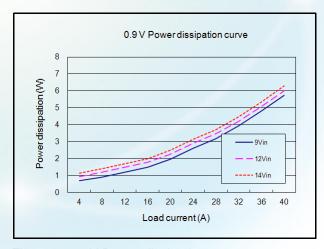


Figure 6: 0.9 V Power dissipation



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Characteristic Curves

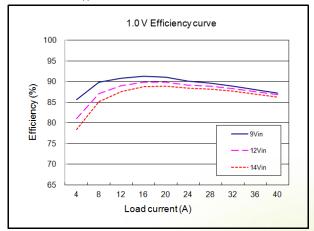


Figure 7: 1.0 V Efficiency

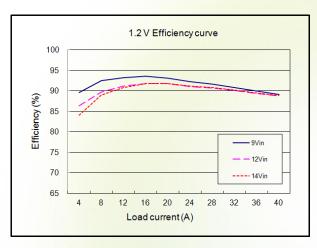


Figure 9: 1.2 V Efficiency

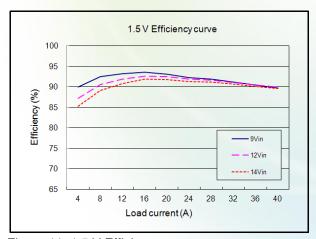


Figure 11: 1.5 V Efficiency

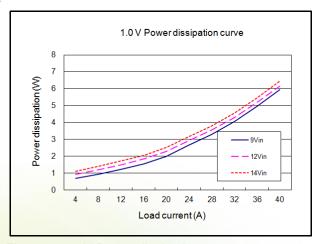


Figure 8: 1.0 V Power dissipation

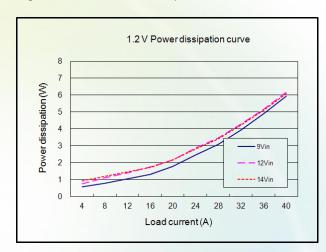


Figure 10:1.2 V Power dissipation

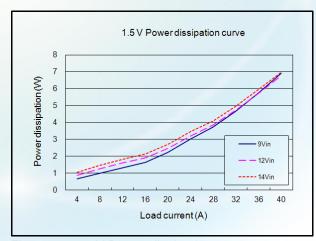


Figure 12: 1.5 V Power dissipation



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Characteristic Curves

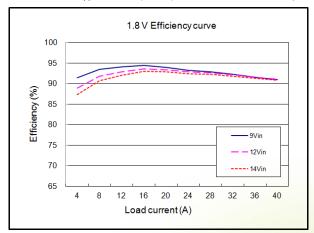


Figure 13: 1.8 V Efficiency

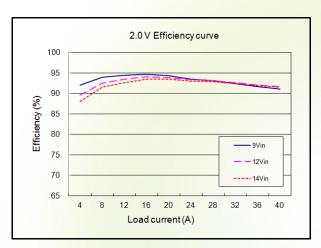


Figure 15: 2.0 V Efficiency

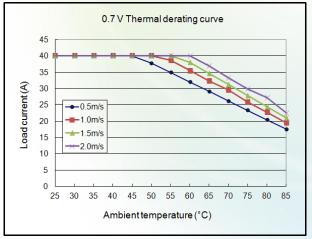


Figure 17: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 0.7 \text{ V}$)

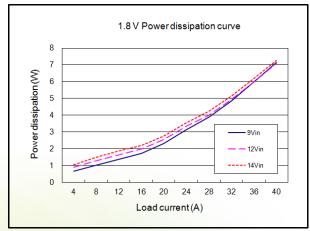


Figure 14: 1.8 V Power dissipation

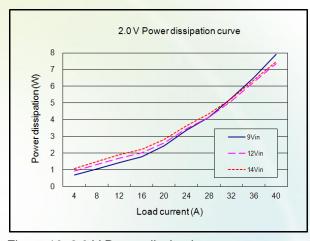


Figure 16: 2.0 V Power dissipation

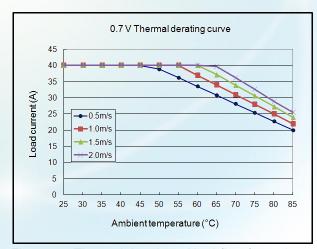


Figure 18: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 0.7 \text{ V}$)



DC-DC Converter Technical Manual V1.2

Characteristic Curves

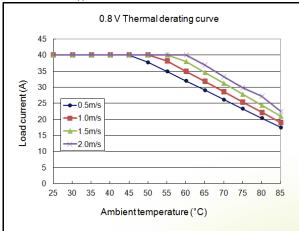


Figure 19: Thermal derating with airflow from pin1 to pin2 (V_{in} = 12 V; V_{out} = 0.8 V)

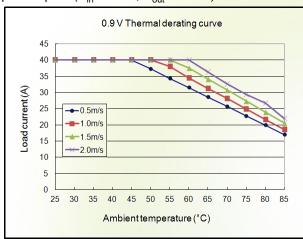


Figure 21: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 0.9 \text{ V}$)

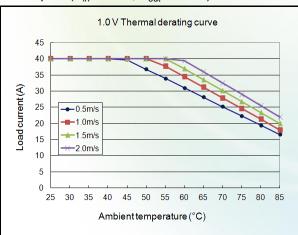


Figure 23: Thermal derating with airflow from pin1 to pin2 (V_{in} = 12 V; V_{out} = 1.0 V)

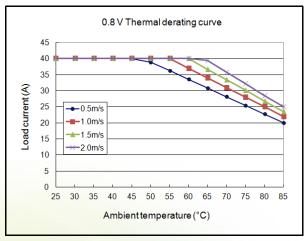


Figure 20: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 0.8 \text{ V}$)

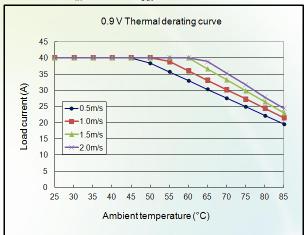


Figure 22: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 0.9 \text{ V}$)

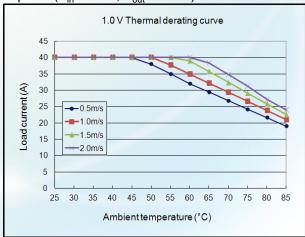


Figure 24: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.0 \text{ V}$)



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Characteristic Curves

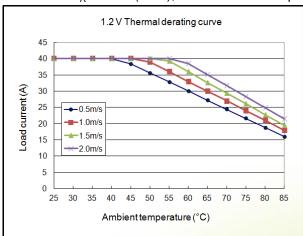


Figure 25: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.2 \text{ V}$)

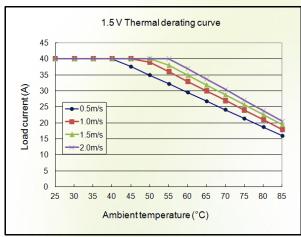


Figure 27: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.5 \text{ V}$)

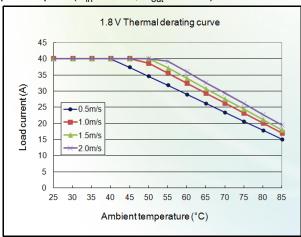


Figure 29: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.8 \text{ V}$)

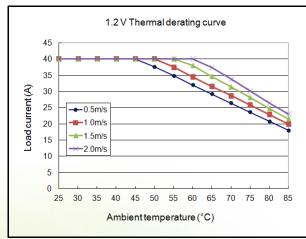


Figure 26: Thermal derating with airflow from pin9 to pin19 (V_{in} = 12 V; V_{out} = 1.2 V)

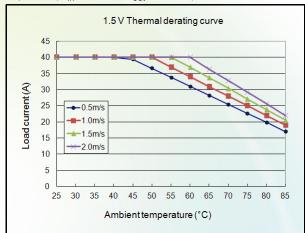


Figure 28: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.5 \text{ V}$)

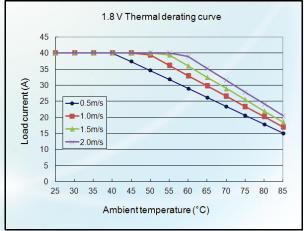


Figure 30: Thermal derating with airflow from pin9 to pin19 ($V_{in} = 12 \text{ V}$; $V_{out} = 1.8 \text{ V}$)



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Characteristic Curves

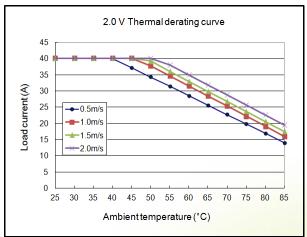


Figure 31: Thermal derating with airflow from pin1 to pin2 ($V_{in} = 12 \text{ V}$; $V_{out} = 2.0 \text{ V}$)

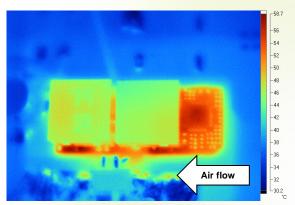


Figure 33: Thermal plot with airflow from pin1 to pin2 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 0.7 \text{ V}$; $I_{out} = 40 \text{ A}$)

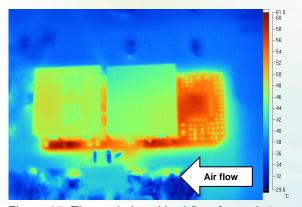


Figure 35: Thermal plot with airflow from pin1 to pin2 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 0.9$ V; $I_{out} = 40$ A)

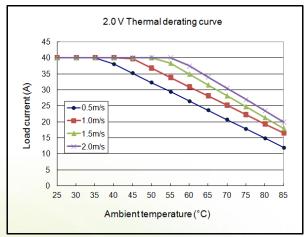


Figure 32: Thermal derating with airflow from pin9 to pin19 (V_{in} = 12 V; V_{out} = 2.0 V)

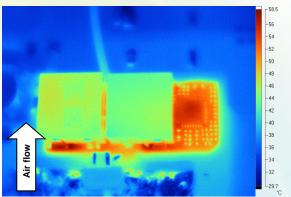


Figure 34: Thermal plot with airflow from pin9 to pin19 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 0.7$ V; $I_{out} = 40$ A)

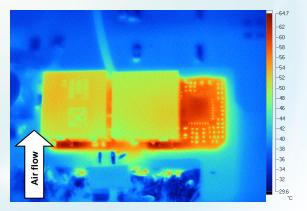


Figure 36: Thermal plot with airflow from pin9 to pin19 ($T_A = 25^{\circ}C$ [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 0.9$ V; $I_{out} = 40$ A)

DC-DC Converter Technical Manual V1.2

Characteristic Curves

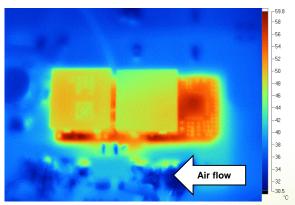


Figure 37: Thermal plot with airflow from pin1 to pin2 ($T_A = 25^{\circ}C$ [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 1.0 \text{ V}$; $I_{out} = 40 \text{ A}$)

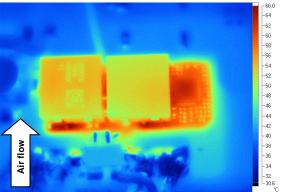


Figure 38: Thermal plot with airflow from pin9 to pin19 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 1.0 \text{ V}$; $I_{out} = 40 \text{ A}$)

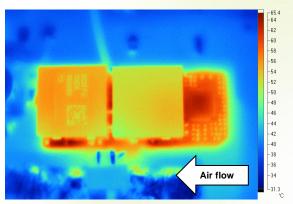


Figure 39: Thermal plot with airflow from pin1 to pin2 ($T_A = 25^{\circ}C$ [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 1.2$ V; $I_{out} = 40$ A)

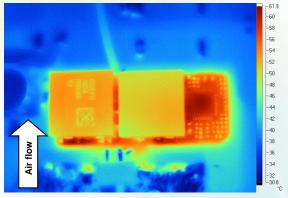


Figure 40: Thermal plot with airflow from pin9 to pin19 ($T_A = 25^{\circ}C$ [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 1.2 \text{ V}$; $I_{out} = 40 \text{ A}$)

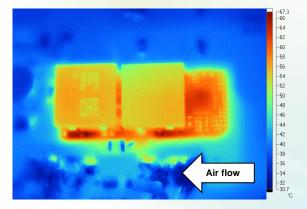


Figure 41: Thermal plot with airflow from pin1 to pin2 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 1.8$ V; $I_{out} = 40$ A)

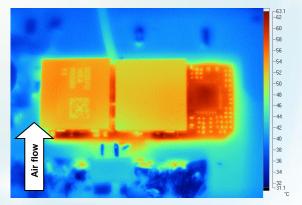


Figure 42: Thermal plot with airflow from pin9 to pin19 ($T_A = 25^{\circ}C$ [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12$ V; $V_{out} = 1.8$ V; $I_{out} = 40$ A)

Characteristic Curves

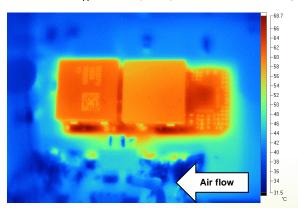


Figure 43: Thermal plot with airflow from pin1 to pin2 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 2.0 \text{ V}$; $I_{out} = 40 \text{ A}$)

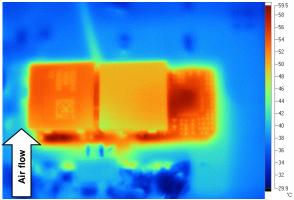


Figure 44: Thermal plot with airflow from pin9 to pin19 ($T_A = 25$ °C [77°F]; Airflow = 1 m/s [200 LFM]; $V_{in} = 12 \text{ V}$; $V_{out} = 2.0 \text{ V}$; $I_{out} = 40 \text{ A}$)

Typical Waveforms

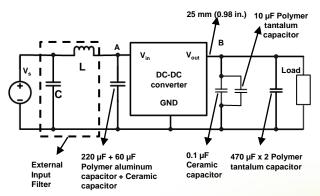


Figure 45: Test set-up diagram



- Measure the output voltage ripple at B (25 mm [0.98 in.] away from the V_{out} pin) shown in Figure 45.
- During the test of input reflected ripple current, the input terminal must be connected to the external input filter (include a 12 µH inductor and a 220 µF electrolytic capacitor), which is not required in other tests.
- 3. Test board: D x W = 200 mm x 110 mm, 10z, 4 layers.

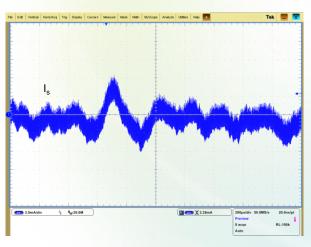


Figure 47: Input reflected ripple current (for point A in the test set-up diagram, $V_{in} = 12 \text{ V}$, $V_{out} = 1.2 \text{ V}$, $I_{out} = 40 \text{ A}$)

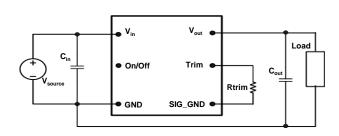


Figure 46: Application guidance



Do not connect the GND and SIG_GND pins outside the converter.

To ensure the stable operating of the converter, the proper capacitors must be add to the input and output terminals.

| Capacitor | Recommend capacitor | | | | | |
|------------------|--|--|--|--|--|--|
| C _{in} | 220 µF: polymer aluminum capacitor | | | | | |
| | 60 μF: ceramic capacitor | | | | | |
| C _{out} | 470 μF x 2: polymer tantalum capacitor | | | | | |

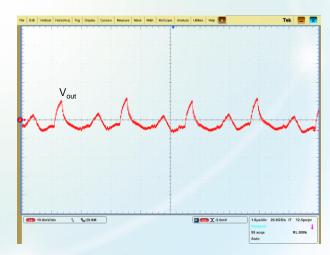


Figure 48: Output voltage ripple (for point B in the test set-up diagram, V_{in} = 12 V, V_{out} = 1.2 V, I_{out} = 40 A)

Typical Waveforms

Conditions: $T_A = 25^{\circ}C$ (77°F), $V_{in} = 12 \text{ V}$.



Figure 49: Startup from On/Off

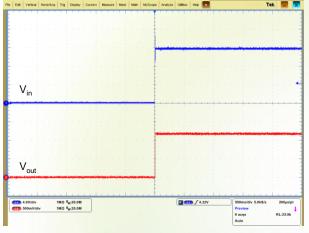


Figure 51: Startup by power on

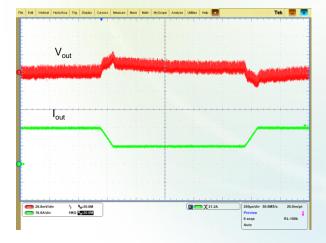


Figure 53: Output voltage dynamic response (Load: 25% - 50% - 25%, di/dt = 1 A/ μ s)

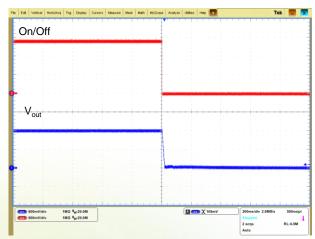


Figure 50: Shutdown from On/Off

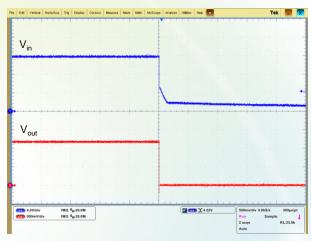


Figure 52: Shutdown by power off

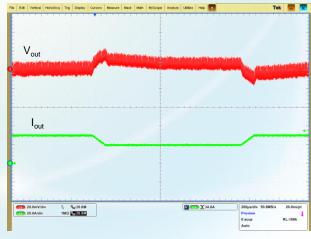


Figure 54: Output voltage dynamic response (Load: 50% - 75% - 50%, di/dt = $1 \text{ A/}\mu\text{s}$)



Remote On/Off

| Logic Enable | On/Off Pin Level | Status |
|-------------------|---------------------|--------|
| Positive logic | Low level | Off |
| | Left open | On |

It is recommended to control the On/Off pin with an open collector transistor or similar device.

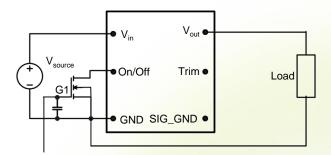


Figure 55: Circuit configuration for On/Off function

The output voltage varies depending on the R_{trim} . Note that the trim resistor tolerance directly affects the output voltage accuracy. It is recommended to use $\pm 1\%$ trim resistor.

The following table describes the mapping between the V_{out} and R_{trim} .

| V _{out} (V) | $R_{trim}(k\Omega)$ |
|----------------------|---------------------|
| 0.7 V | 6.00 |
| 0.9 V | 2.00 |
| 1.0 V | 1.50 |
| 1.2 V | 1.00 |
| 1.8 V | 0.50 |
| 2.0 V | 0.43 |

Output Voltage Trim

Output voltage can be adjusted by installing an external resistor between the Trim pin and the SIG_GND pin.

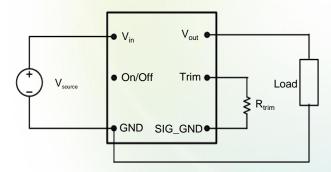


Figure 56: R_{trim} external connections

The relationship between R_{trim} and V_{out}:

$$R_{trim} = \left[\frac{0.6}{V_{out} - 0.6} \right] k\Omega$$

Remote Sense

The remote sense feature compensates for the voltage drop between the output pins of the converter and the load. The Sense should be connected at the load or at the point where regulation is required. The maximum compensation voltage is 0.1 V.

If the remote sense function is disabled, leave the Sense pin open.

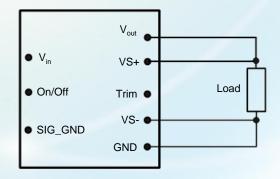


Figure 57: Configuration diagram for remote sense

Input Undervoltage Protection

The converter will shut down after the input voltage drops below the undervoltage protection threshold for shutdown. The converter will start to work again after the input voltage reaches the input undervoltage protection threshold for startup. For the Hysteresis, see the *Protection characteristics*.

Output Overcurrent Protection

The converter equipped with current limiting circuitry can provide protection from an output overload or short circuit condition. If the output current exceeds the output overcurrent protection set point, the converter enters hiccup mode. When the fault condition is removed, the converter will automatically restart.

Output Overvoltage Protection

When the voltage directly across the output pins exceeds the output overvoltage protection threshold, the converter will stop working to protect the converter and the load. The converter will automatically resumes normal operation after the over voltage condition is removed.

Overtemperature Protection

A temperature sensor on the converter senses the average temperature of the module. It protects the converter from being damaged at high temperatures. When the temperature exceeds the Overtemperature protection threshold, the output will shut down. It will allow the converter to turn on again when the temperature of the sensed location falls by the value of Overtemperature Protection Hysteresis.

PCB Layout Considerations

To ensure the filtering effects, place the C_{in} and C_{out} symmetrically near the pins. The following figure shows the cable hole layouts at the input and output terminals.

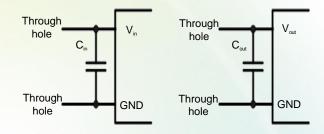


Figure 58: Recommend PCB layout

Qualification Testing

| Parameter | Units | Condition |
|---|-------|---|
| High Accelerated Life Test (HALT) | 4 | Lowest operating temperature: -60°C (-76°F); highest operating temperature: 120°C (248°F); vibration limit: 40 G |
| Power Temperature Cycle (PTC) | 16 | Rated input voltage, 50% - 80% load; 1000 temperature cycles between -40°C (-40°F) and + 55°C 131°F) with the temperature change rate of 5°C (41°F) - 10°C (50°F) per minute; Lasting for 30 minutes both at -40°C (-40°F) and + 55°C (131°F) |
| Temperature Humidity Bias (THB) | 16 | Maximum input voltage; 85°C (185°F); 85% RH; 1000 operating hours under lowest load power |
| High Temperature Operation Bias (HTOB) | 16 | Rated input voltage; air flow: 0.5 m/s (100 LFM) to 5 m/s (1000 LFM); 1000 operating hours under 50% - 80% load power; air temperature: 45°C (113°F) - 55°C (131°F) |

Thermal Consideration

Thermal Test Point

Sufficient airflow should be provided to ensure reliable operating of the converter. Therefore, thermal components are mounted on the converter to dissipate heat to the surrounding environment by conduction, convection and radiation. Decide proper airflow to be provided by measuring the temperature of the MOSFET as shown in Figure 59 to protect the converter against overtemperature. The Overtemperature protection threshold is also obtained based on thermal test point.

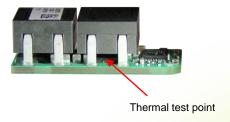


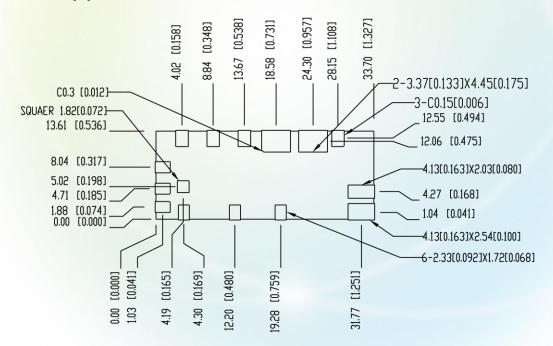
Figure 59: Thermal test point

Power Dissipation

The converter power dissipation is calculated based on efficiency. The following formula reflects the relationship between the consumed power (P_d) , efficiency (η) , and output power (P_o) : $P_d = P_o(1 - \eta) / \eta$

Recommended Pad Layout

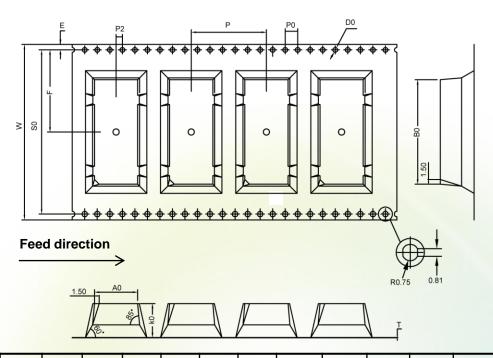
Unit of measurement: mm [in.]



Package Information

The converters are supplied in tape & reel as standard. The following figure shows the tape dimensions.

Unit of measurement: mm [in.]



| ITEM | W | A0 | B0 | K0 | Р | F | Е | S0 | D0 | P0 | P2 | Т |
|------|-------|-------|-------|------|-------|-------|------|----------------|------|------|------|----------------|
| DIM | 56.00 | 13.90 | 33.45 | 11.1 | 24.00 | 26.20 | 1.75 | 52.40 | 1.50 | 4.00 | 2.00 | 0.5 |
| | | | | | | | | +0.10 -0.10 | | | | +0.05 -0.05 |

Moisture Sensitivity Level (MSL) Rating

The converters have a MSL rating of 2a.

Mechanical Consideration

Soldering

The converter is compatible with reflow soldering techniques. No wave soldering and hand soldering is allowed.

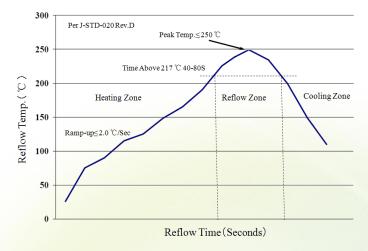


Figure 60: Recommended reflow profile using lead-free solder

HUAWEI TECHNOLOGIES CO., LTD.

Huawei Industrial Base Bantian Longgang Shenzhen 518129 People's Republic of China www.huawei.com

